

Features

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- **Lead, Halogen and Antimony Free, RoHS Compliant (Note 3)**
- **"Green" Device (Note 4)**
- **Qualified to AEC-Q101 Standards for High Reliability**

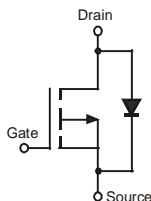
Mechanical Data

- Case: SOT-23
- Case Material: UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish).
- Terminal Connections: See Diagram
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.008 grams (approximate)

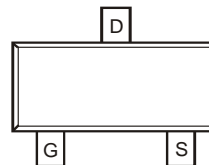
SOT-23



Top View



Equivalent Circuit



Top View

Maximum Ratings @T_A = 25°C unless otherwise specified

| Characteristic | Symbol | Value | Units |
|---|------------------|-------|-------|
| Drain-Source Voltage | V _{DSS} | -50 | V |
| Drain-Gate Voltage R _{GS} ≤ 20KΩ | V _{DGR} | -50 | V |
| Gate-Source Voltage Continuous | V _{GSS} | ±20 | V |
| Drain Current (Note 1) Continuous | I _D | -130 | mA |
| Pulsed Drain Current | I _{DM} | -1.2 | A |

Thermal Characteristics @T_A = 25°C unless otherwise specified

| Characteristic | Symbol | Value | Units |
|---|-----------------------------------|-------------|-------|
| Total Power Dissipation (Note 1) | P _D | 300 | mW |
| Thermal Resistance, Junction to Ambient | R _{θJA} | 417 | °C/W |
| Operating and Storage Temperature Range | T _J , T _{STG} | -55 to +150 | °C |

Electrical Characteristics @T_A = 25°C unless otherwise specified

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Condition |
|-----------------------------------|----------------------|------|-----|------|------|--|
| OFF CHARACTERISTICS (Note 2) | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | -50 | — | — | V | V _{GS} = 0V, I _D = -250μA |
| Zero Gate Voltage Drain Current | I _{DSS} | — | — | -15 | μA | V _{DS} = -50V, V _{GS} = 0V, T _J = 25°C |
| | | — | — | -60 | μA | V _{DS} = -50V, V _{GS} = 0V, T _J = 125°C |
| | | — | — | -100 | nA | V _{DS} = -25V, V _{GS} = 0V, T _J = 25°C |
| Gate-Body Leakage | I _{GSS} | — | — | ±10 | nA | V _{GS} = ±20V, V _{DS} = 0V |
| ON CHARACTERISTICS (Note 2) | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | -0.8 | — | -2.0 | V | V _{DS} = V _{GS} , I _D = -1mA |
| Static Drain-Source On-Resistance | R _{DS (ON)} | — | — | 10 | Ω | V _{GS} = -5V, I _D = -0.100A |
| Forward Transconductance | g _{FS} | 0.05 | — | — | S | V _{DS} = -25V, I _D = -0.1A |
| DYNAMIC CHARACTERISTICS | | | | | | |
| Input Capacitance | C _{iss} | — | — | 45 | pF | V _{DS} = -25V, V _{GS} = 0V, f = 1.0MHz |
| Output Capacitance | C _{oss} | — | — | 25 | pF | |
| Reverse Transfer Capacitance | C _{rss} | — | — | 12 | pF | |
| SWITCHING CHARACTERISTICS | | | | | | |
| Turn-On Delay Time | t _{D(ON)} | — | 10 | — | ns | V _{DD} = -30V, I _D = -0.27A, R _{GEN} = 50Ω, V _{GS} = -10V |
| Turn-Off Delay Time | t _{D(OFF)} | — | 18 | — | ns | |

- Notes:
1. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.
 2. Short duration pulse test used to minimize self-heating effect.
 3. No purposefully added lead. Halogen and Antimony Free.
 4. Product manufactured with Data Code V9 (week 33, 2008) and newer are built with Green Molding Compound. Product manufactured prior to Date Code V9 are built with Non-Green Molding Compound and may contain Halogens or Sb₂O₃ Fire Retardants.

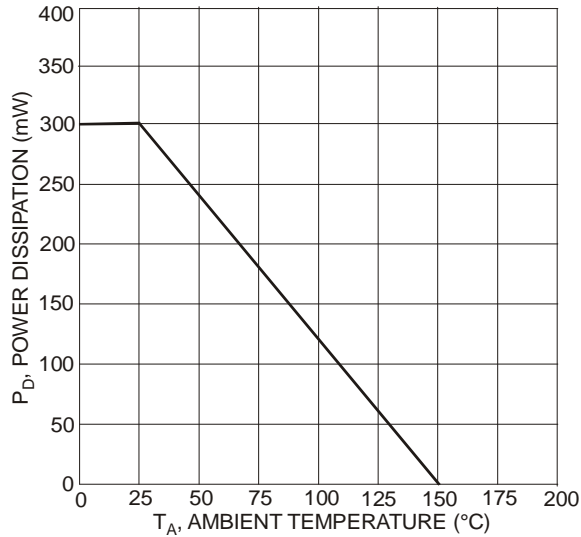


Fig. 1 Max Power Dissipation vs. Ambient Temperature

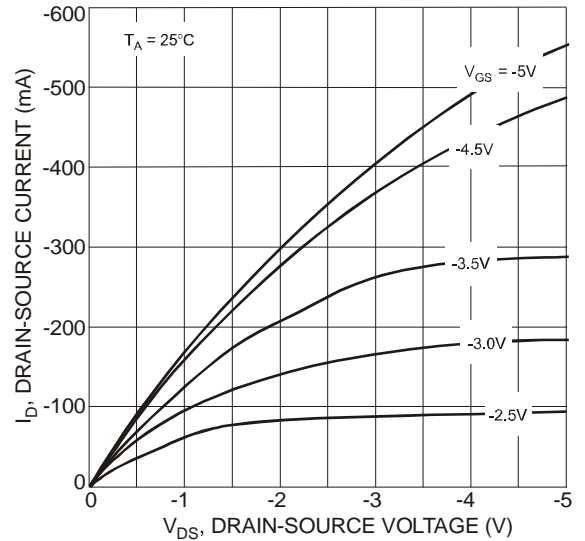


Fig. 2 Drain-Source Current vs. Drain-Source Voltage

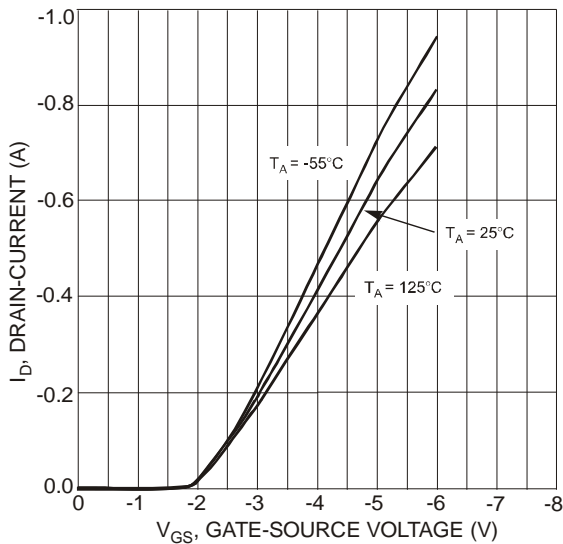


Fig. 3 Drain-Current vs. Gate-Source Voltage

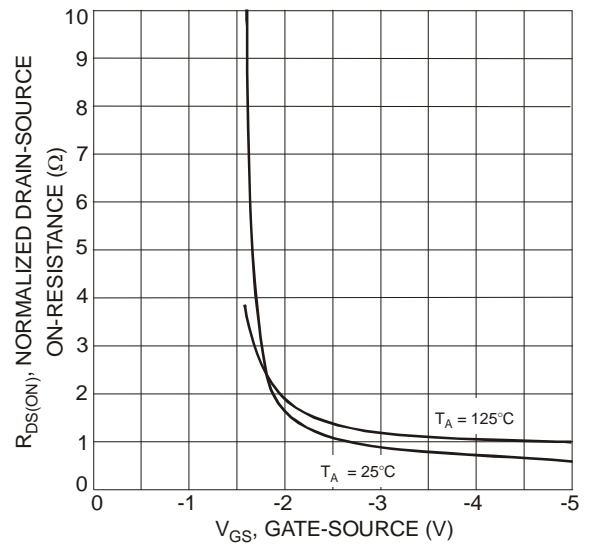


Fig. 4 On-Resistance vs. Gate-Source Voltage

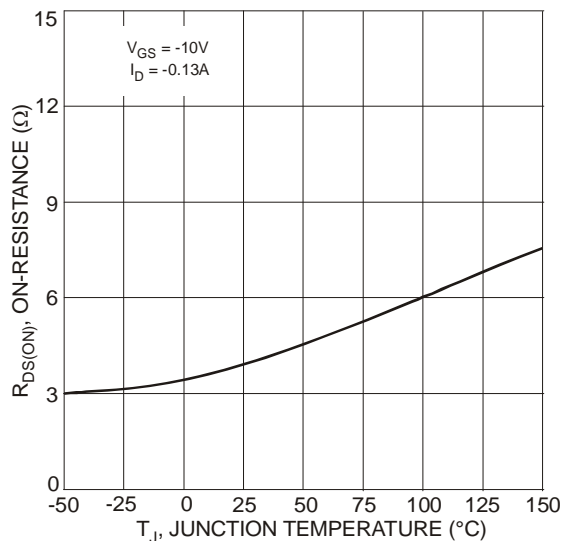


Fig. 5 On-Resistance vs. Junction Temperature

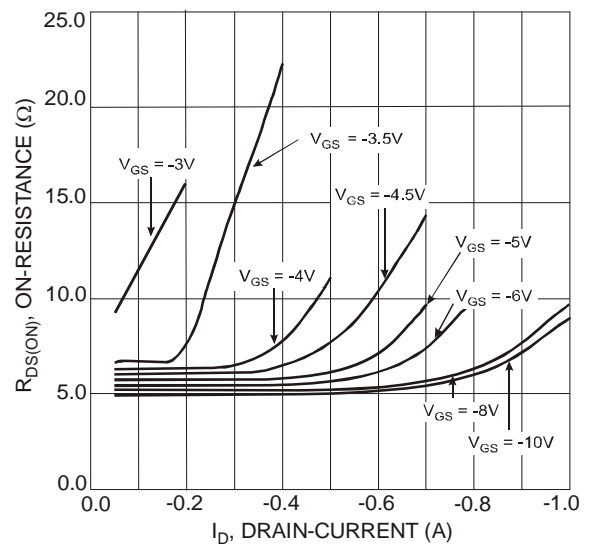


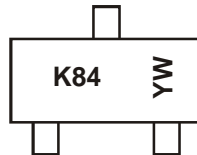
Fig. 6 On-Resistance vs. Drain-Current

Ordering Information (Note 5)

| Part Number | Case | Packaging |
|-------------|--------|------------------|
| BSS84-7-F | SOT-23 | 3000/Tape & Reel |

Notes: 5. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

Marking Information



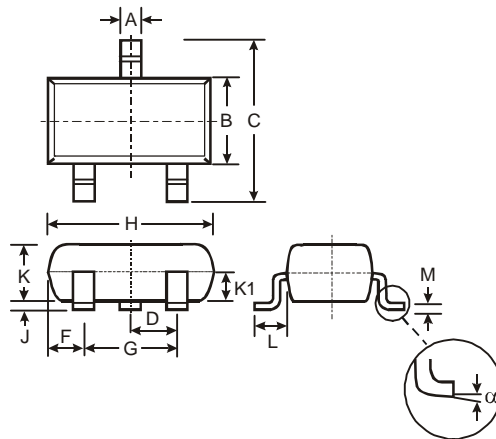
K84 = Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex: N = 2002)
 M = Month (ex: 9 = September)

Date Code Key

| Year | 1998 | 1999 | 2000 | 2001 | 2002 | 2003 | 2004 | 2005 | 2006 | 2007 | 2008 | 2009 | 2010 | 2011 | 2012 |
|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|
| Code | J | K | L | M | N | P | R | S | T | U | V | W | X | Y | Z |

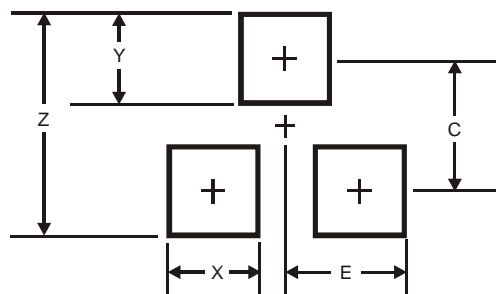
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
|-------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | O | N | D |

Package Outline Dimensions



| SOT-23 | | | |
|----------------------|-------|------|-------|
| Dim | Min | Max | Typ |
| A | 0.37 | 0.51 | 0.40 |
| B | 1.20 | 1.40 | 1.30 |
| C | 2.30 | 2.50 | 2.40 |
| D | 0.89 | 1.03 | 0.915 |
| F | 0.45 | 0.60 | 0.535 |
| G | 1.78 | 2.05 | 1.83 |
| H | 2.80 | 3.00 | 2.90 |
| J | 0.013 | 0.10 | 0.05 |
| K | 0.903 | 1.10 | 1.00 |
| K1 | - | - | 0.400 |
| L | 0.45 | 0.61 | 0.55 |
| M | 0.085 | 0.18 | 0.11 |
| α | 0° | 8° | - |
| All Dimensions in mm | | | |

Suggested Pad Layout



| Dimensions | Value (in mm) |
|------------|---------------|
| Z | 2.9 |
| X | 0.8 |
| Y | 0.9 |
| C | 2.0 |
| E | 1.35 |

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